# Evaluating the ADM1272 High Voltage Positive Hot Swap Controller and Digital Power Monitor with PMBus 

## FEATURES

Fully functional support evaluation kit for the ADM1 272
Populated and tested with $\mathbf{4 8} \mathrm{V}, \mathbf{3 0} \mathrm{A}, 1 \mathrm{mF}$ design 40 V undervoltage and 60 V overvoltage settings Custom N-MOSFET footprint suits different packages
Supports up to 2 sense resistors in parallel
Supports up to 4 FETs in parallel
LED indicated status outputs
Wide input voltage range: 16 V to $\mathbf{8 0} \mathrm{V}$
120 V absolute maximum
FET temperature measurement capability
Supports cascade setup for multiple boards
Toggle and push-button switch for easy input control
PMBus ( $I^{2} \mathrm{C}$ ) communication supported

## PACKAGE CONTENTS

EVAL-ADM1272EBZ evaluation board

## ADDITIONAL HARDWARE NEEDED

Serial input/output interface, USB-SDP-CABLEZ (not included in the evaluation kit, must be ordered separately)
Only one dongle is required in multiple board cascade setup

## SOFTWARE NEEDED

Analog Devices, Inc., hot swap and power monitoring evaluation software (download from ADM1272 product page)

## GENERAL DESCRIPTION

The EVAL-ADM1272EBZ is a compact, full featured evaluation board for the ADM1272. The board layout provides a clear visual of all the peripheral components and the hot swap power path. The layout also maximizes the ability of the board to dissipate heat for some of the key components on the power path, allowing the evaluation of high current hot swap setups.
Two sense resistor slots and four (two on the bottom side) multipackage FET slots provide great flexibility and allow a wide range of application setups.

Multiple test points allow easy access to all critical points and pins. Six LEDs provide direct visual indication on variations in the board status, such as supply input, output, GPIO1, GPIO2, power good, and fault.
The kit supports PMBus ${ }^{\text {mit }}$ communication, allowing the user to communicate with the ADM1272. The evaluation kit also supports cascade setup so that multiple evaluation boards can be connected together and share the same PMBus.

The boards are fully compatible with the ADM1272 evaluation software, which can be downloaded from the ADM1272 product page.
A USB-to- $\mathrm{I}^{2} \mathrm{C}$ dongle (USB-SDP-CABLEZ) is required to use the evaluation software.

The standard evaluation kit is prepopulated and tested with a $48 \mathrm{~V}, 30 \mathrm{~A}$ hot swap design capable of working with a 1 mF output capacitor.
Complete specifications for the ADM1272 are available in the ADM1272 data sheet, which must be consulted in conjunction with this user guide when using the evaluation board.

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## REVISION HISTORY

## 4/2017—Revision 0: Initial Version

## EVALUATION BOARD PHOTOGRAPH



Figure 1.

## QUICK START GUIDE

To set up and start using the evaluation board, take the following steps:

1. Download the hot swap and power monitoring software from the ADM1272 product page (see the UG-353 for more information).
2. Connect the evaluation board (EVAL-ADM1272EBZ) to a PC through the 10 -way connector and the USB-to- $\mathrm{I}^{2} \mathrm{C}$ dongle (USB-SDP-CABLEZ).
3. Connect the power supply to the evaluation board using thick wires suitable for the current levels to be observed.
4. To confirm that the boards are configured correctly, set the output of the power supply to 48 V with less than 1 A current limit and with no load capacitance. If the boards are configured correctly, the green LED (labeled PWRGD) on the evaluation board illuminates.
5. Push the ENABLE switch to the off position or press the push button on the evaluation board. The green LED (labeled PWRGD) turns off and then turns back on again when reenabled.
6. The restart signal can be provided using the RST switch (S3). Pressing this switch disables the output, and it is automatically reenabled after the restart time has elapsed (default is approximately 10 sec ).
7. If a fault event occurs (for example, a short circuit during operation), the red LED (labeled FAULT) illuminates. This fault can be cleared by toggling the ENABLE pin after the fault condition has been removed.
8. Disable the hot swap using the Hot Swap Control section in the Basic Operation tab of the software graphical user interface (GUI). Disabling the hot swap turns off the green LED (labeled PWRGD) on the evaluation board.
9. Manually program the sense resistor value, if required, using the options in the GUI.
10. Check that the voltage and current measurements are as expected (for example, VIN $=48 \mathrm{~V}$ ) in the Power Monitor tab of the software GUI.

## EVAL-ADM1272EBZ User Guide

## EVALUATION BOARD DESCRIPTION

The EVAL-ADM1272EBZ evaluation board is designed to demonstrate several features of the ADM1272. A simplified diagram of the evaluation board is shown in Figure 2.
The evaluation board is connected to a PC using a USB-to- $\mathrm{I}^{2} \mathrm{C}$ dongle (USB-SDP-CABLEZ) for PMBus communication. The evaluation board is shown in Figure 1.

To minimize inductance and losses, use appropriately rated wires between the power supply, the evaluation board connectors, and the load. There is only one GND connector, so the main system current does not normally flow through the evaluation board.

## CONFIGURATION

The EVAL-ADM1272EBZ evaluation board is configured to operate between 40 V and 60 V , with a current limit of 30 A . Loads with up to $1000 \mu \mathrm{~F}$ of capacitance can be connected. This capacitance is not included on the board, because it is intended to be plugged into a system where load capacitance already exists. If load capacitance does not already exist, add capacitance across the load using the J2 (VOUT) and J3 (GND) connectors, or solder across D6 and/or on the bottom side pads under D6. To prevent faults at power up, take care to avoid any dc loads being enabled until after PWRGD is asserted.


Figure 2. Basic ADM1272 Connection Diagram

## MOSFETS

The EVAL-ADM1272EBZ uses a custom MOSFET footprint, shown in Figure 3, to accommodate a variety of common MOSFET packages. Examples include D2PAK, DPAK, LFPAK, and other SO-8 variants.


Figure 3. Multipackage N-Channel MOSFET Footprint

## SENSE RESISTORS

For optimum current sensing accuracy with standard 2512 sense resistors, the footprint shown in Figure 4 is preferred. This footprint may not be optimized to all resistors, and results may vary depending on resistor composition and size.

The center pads are used as the Kelvin connection to sense the voltage at the resistor. Some resistors provide more accurate results if sensed at the outer edge of the resistor (labeled A in Figure 4). Alternatively, the user can configure the sense connections to be made through center locations (labeled B in Figure 4), which may yield better results for certain resistor types. The board can be configured through the eight resistors located on the underside of the printed circuit board (PCB), directly under the sense resistors. R7O, R8O, R17O, and R18O connect the outside vias (labeled A in Figure 4), and R7I, R8I, R17I, and R18I connect the inside vias (labeled B in Figure 4). The outside vias are connected by default.

Sense resistors must be tested independently. It is the responsibility of the user to ensure that the layout dimensions and structure of the footprint comply with individual SMT manufacturing requirements.


Figure 4. Sense Resistor—Kelvin Footprint
BOARD SPECIFICATIONS
Table 1.

| Parameter | Typical Value | Unit |
| :--- | :--- | :--- |
| Load Capacitance | 1000 | $\mu \mathrm{~F}$ |
| Severe Circuit Breaker Current | 60 | A |
| Normal Current Limit | 30 | A |
| Start-Up Current Limit | 4 | A |
| Maximum Ambient Temperature | 60 | ${ }^{\circ} \mathrm{C}$ |
| Undervoltage (UV) Falling Threshold (UVL) | 39.7 | V |
| UV Rising Threshold (UVH) | 41.2 | V |
| Overvoltage (OV) Rising Threshold | 60 | V |
| PWRGD Falling Threshold | 40.2 | V |

## EVALUATION BOARD HARDWARE CONNECTOR, SWITCH, AND LED FUNCTIONS

Table 2. Connector Functions

| Connector | Description |
| :--- | :--- |
| J1 | Hot swap line voltage input, which also powers the board. Input voltage is 40 V to 60 V. |
| J2 | Hot swap line voltage output. Connect to load. |
| J3 | GND connector. |
| J4 | Can be used to connect PMBus nodes to system host or dongle. Pin 1 is SCL. Pin 2 is SDA. Pin 3 is GND (top). |
| J5 | 10-way connector for USB-SDP-CABLEZ PMBus connection. |

Table 3. Switch Functions

| Switch | Description |
| :--- | :--- |
| S1 | Toggle switch for the ENABLE pin. Up means on. |
| S2 | Push-button switch for the ENABLE pin. Push to reset. |
| S3 | Push-button switch for the $\overline{\text { RESTART }}$ pin. Push to disable the output and automatically reenable after the restart <br> time has elapsed (default is approximately 10 sec). |

Table 4. LED Functions

| LED | Description |
| :--- | :--- |
| DVIN | Board input power; green. |
| DVOUT | Board output power; green. |
| DPG | Power good; green (LED on means PWRGD high). |
| DF | $\overline{\text { FAULT; red (LED on means FAULT low). }}$ |
| DG1 | GPO1; blue (LED on means GPIO1 high). |
| DG2 | GPO2; blue (LED on means GPIO2 high). |

## EVALUATION BOARD SCHEMATICS AND ARTWORK



Figure 5. Evaluation Board Schematic—Main Circuitry


Figure 6. Evaluation Board Schematic—Connectors and Miscellaneous


Figure 7. Top Layer 1


Figure 8. Inner Layer 2


Figure 9. Inner Layer 3


Figure 10. Bottom Layer

## ORDERING INFORMATION

## BILL OF MATERIALS

Table 5.

| Reference Designator | Description | Manufacturer/Part Number |
| :---: | :---: | :---: |
| C1 | Do not install (C1206) | Not applicable |
| C2 | Do not install (C0805) | Not applicable |
| C4, C9, C11 | Capacitor, chip, ceramic, X7R | Murata, GCM21BR71E105KA56L |
| C5, C16 | Do not install (C0603) | Not applicable |
| C6 to C8 | Capacitor, ceramic, X7R | Kemet, C0805C104J5RACTU |
| C10 | Capacitor, ceramic, X7R | Murata, GRM188R71H103KA01D |
| C12 | Capacitor, ceramic, X7S | TDK, C2012X7S2A105K125AB |
| C13 | Capacitor, ceramic, 0603, X7R | Kemet, C0603X473K5RAC7867 |
| C14 | Capacitor, ceramic, X7R, 0603, $16 \mathrm{~V}, 10 \%$ | Yageo, 06035C223KAZ2A |
| C15 | Capacitor, ceramic, X7R, commercial grade | Kemet, C0805C473K1RACTU |
| C17 | Capacitor, ceramic, X7R | AVX, 08051C104JAT2A |
| D1, D5 | Do not install (diode, Schottky) | STMicroelectronics, BAT54ZFILM |
| D2 | Diode, TVS, unidirectional | Littelfuse, Inc., SMCJ64A |
| D3 | Diode, Zener | Diodes, Inc., MMSZ5226B-7-F |
| D4 | Diode, Zener, voltage regulator | ON Semiconductor, MMSZ5V1T1G |
| D6 | Diode, Schottky, barrier rectifier, 3.0 A | Diodes, Inc., B380-13-F |
| DF | Diode, LED, red, clear, 660 nm wavelength peak | Lumex, Inc., SML-LX0805SRC-TR |
| DG1, DG2 | Diode, LED, blue, clear, 470 nm wavelength peak | Lumex, Inc.,SML-LX0805USBC-TR |
| DPG, DVIN, DVOUT | LED, super ultragreen, water clear lens | Lumex, Inc., SML-LX0805SUGC-TR |
| G, DV, EF, EN, ES, G1, G2, IS, PG, SN, SP, FLT, IST, MCB, PIN, RND, RST, V35 | Do not install (connector, PCB, PC board pin) | Not applicable |
| J1 to J3 | Connector, PCB, screw terminal, vertical | Keystone, 8191 |
| J4 | Connector, PCB, Berg, header, straight, male, 3-pin | Samtec, TSW-103-08-G-S |
| J5 | Connector, PCB , board to board and mezzanine, micromatch | TE Connectivity, 8-215079-0 |
| LK1,LK2,R27,R30,R52,R58,R59,R44, R45 | Resistor, film, SMD, 0603 | Yageo, RC0603FR-072K49L |
| Q1, Q2 | Transistor, N-channel, MOSFET, 0.0048 , RDS-ON | NXP Semiconductors, PSMN4R8-100BSE |
| Q3, Q4 | Do not install | NXP Semiconductors, PSMN4R8-100BSE |
| Q5 to Q8, Q10, Q12 | Transistor, N-channel, enhance mode, FET | Fairchild, 2N7002 |
| Q11 | Transistor, NPN, Darlington | Diodes, Inc., FZT605 |
| Q9 | Transistor, MMBT3904, NPN, SOT-23 | Fairchild, MMBT3904 |
| R1 | Resistor, power, SMD, 3520 series, 5\%, 1 W, 2512 | TE Connectivity, 3520390RJT |
| R10, R11, R32 | Resistor, precision, thick film, chip | Panasonic, ERJ-3EKF1003V |
| R55, R56 | Do not install | Panasonic, ERJ-3EKF1003V |
| R12 | Resistor, metal film, high reliability | Panasonic, ERA-3AEB2551V |
| R3, R13, R31, R44, R45, R50, R51, R53, R54, R57, R60, R71, R81, R171, R18I | Do not install (R0603) | Not applicable |
| R14 | Resistor, film, SMD 0603 | Panasonic, ERJ-3EKF1691V |
| R15, R34 | Resistor, precision, thick film, chip, R0603 | Panasonic, ERJ-3EKF2321V |
| R16 | Resistor, general-purpose, chip | Yageo, RC0603FR-072K49L |
| R17 to R20, R7O, R8O, R170, R180 | Resistor, precision, thick film, chip, R0603 | Panasonic, ERJ-3EKF10R0V |
| R2, R24, R26, R37, R38 | Resistor, precision, thick film, chip, R0603 | Panasonic, ERJ-3EKF1001V |
| R21, R22 | Resistor, metal film, chip | Panasonic, ERA-6AEB183V |
| R23, R25, R36, R40, R41, R48, R49 | Resistor, thick film, chip | Panasonic, ERJ-3EKF1002V |
| R28, R29 | Do not install (R0805) | Not applicable |
| R33 | Resistor, precision, thick film, chip, R0603 | Vishay, CRCW06036R34FKEA |
| R35 | Resistor, metal film, high reliability | Panasonic, ERA-3YEB153V |
| R39 | Resistor, film, SMD, 0805 | Meggit, RN73C2A20KBTDF |
| R4 to R6, R9 | Resistor, precision, thick film, chip, R0805 | Panasonic, ERJ-6ENF1003V |


| Reference Designator | Description | Manufacturer/Part Number |
| :--- | :--- | :--- |
| R42 | Do not install (R0603) | Not applicable |
| R43 | Resistor, film, SMD, 0603 | Susumi, RR0816P-334-D |
| R46, R47 | Resistor, film, SMD, 0603 | Panasonic, ERJ-3EKF3301V |
| R7 | Resistor, film, SMD, 0805 | Panasonic, ERJ-6ENF2202V |
| R8 | Resistor, precision, thick film, chip, R0603 | Panasonic, ERJ-3EKF1000V |
| RSENSE2 | Resistor, customized pad layout of metal element current sense | TT Electronics, ULRG32512R001FLFSLT |
| RSENSE1 | Do not install | Not applicable |
| S1 | Switch, PC mount, slide switch | E-Switch, EG1218 |
| S2, S3 | Switch, tactile, SPST-NO | C\&K Components, KMR211GLFS |
| U1 | IC, high voltage positive swap controller and digital power | Analog Devices, Inc., ADM1272-1ACPZ |
|  | monitor with PMBus |  |

## RELATED LINKS

| Resource | Description |
| :--- | :--- |
| ADM1272 | Product Page, High Voltage Positive Hot Swap Controller and Digital Power Monitor with PMBus |

$1^{2} \mathrm{C}$ refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).


## ESD Caution

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## Legal Terms and Conditions

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